



鍍層厚度:

Blank : 1u"
2 : 15u"
3 : 30u"

SPECIFICATIONS

Electrical:

- 1.Rating: 5.0 A
- 2.Dielectric Withstand Voltage: 100V AC
- 3.Contact Resistance: 40 mΩ Max
- 4.Insulation Resistance: 100 MΩ Min

Mechanical:

- 1.Connector Mate and Unmate Force
 - 1.1 Mate force: 5~20 N
 - 1.2 Unmate force: 8~20 N

Material:

- 1.Housing: LCP
- 2.Contact: C1814
- 3.Shell: SUS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

PIN DEFINITION FRONT VIEW

A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1
GND			VBus		D-	D+	CC	VBus			GND
GND			VBus	Vconn				VBus			GND
B1	B2	B3	B4	B5	B6	B7	B8	B9	B10	B11	B12

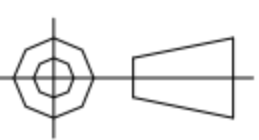


東莞市高迪電子有限公司
DONG GUAN GAO DI ELECTRONICS CO., LTD

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
DATE: 06/17/22

CHECKED BY: Jacky Chen
DATE: 06/17/22

APPROVED BY: Tony Kao
DATE: 06/17/22

MAT'L		TITLE	CONNECTOR
FINISH		MODLE	USB C TYPE
SCALE	1 : 1	DWG NO.	GD-CMB-140FA SERIES
SHEET NO.	1 of 1	PART NO.	
			SIZE A4
			VER R2